

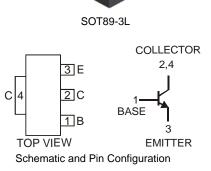


CX56/-16

NPN SURFACE MOUNT TRANSISTOR

Features

- **Epitaxial Planar Die Construction**
- Complementary PNP Type Available (DCX53)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- **Mechanical Data**
- Case: SOT89-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	100	V
Collector-Emitter Voltage	V _{CEO}	80	V
Emitter-Base Voltage	V _{EBO}	5	V
Collector Current	lc	1	A
Peak Pulse Current	I _{CM}	1.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ $T_A = 25^{\circ}C$	PD	1	W
Operating and Storage Temperature Range	Tj, T _{STG}	-55 to +150	°C
Thermal Resistance, Junction to Ambient Air (Note 3) @T _A = 25°C	R _{0JA}	125	°C/W

Electrical Characteristics @T_A = 25°C unless otherwise specified

Charac	teristic	Symbol	Min	Тур	Max	Unit	Test Conditions
OFF CHARACTERISTICS (N	ote 4)						·
Collector-Base Breakdown Voltage		V _{(BR)CBO}	100	_		V	$I_{C} = 100 \mu A, I_{E} = 0$
Collector-Emitter Breakdown Voltage		V _{(BR)CEO}	80	_		V	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Volta	age	V _{(BR)EBO}	5.0	—		V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector-Base Cutoff Current		I _{CBO}	_	_	0.1 20	μΑ	$V_{CB} = 30V, I_E = 0$ $V_{CB} = 30V, I_E = 0, T_A = 150^{\circ}C$
Emitter-Base Cutoff Current		I _{EBO}	_	_	100	nA	$V_{EB} = 5.0V, I_{C} = 0$
ON CHARACTERISTICS (No	te 4)						
DC Current Gain	DCX56, DCX56-16	h _{FE}	63 40	_			$I_{C} = 5.0 \text{mA}, V_{CE} = 2.0 \text{V}$ $I_{C} = 500 \text{mA}, V_{CE} = 2.0 \text{V}$
	DCX56		63	_	250	_	I _C = 150mA, V _{CE} = 2.0V
	DCX56-16		100	_	250	_	I _C = 150mA, V _{CE} = 2.0V
Collector-Emitter Saturation V	oltage	V _{CE(SAT)}	_	_	0.5	V	$I_{\rm C} = 500$ mA, $I_{\rm B} = 50$ mA
Base-Emitter Turn-On Voltage	9	V _{BE(ON)}	_	_	1.0	V	I _C = 500mA, V _{CE} = 2.0V
SMALL SIGNAL CHARACTE	RISTICS						
Current Gain-Bandwidth Prod	uct	f _T		200		MHz	$I_C = 50$ mA, $V_{CE} = 5V$, f = 100MHz
Output Capacitance		C _{obo}	_	_	15	pF	$V_{CB} = 10V, I_E = 0, f = 1MHz$

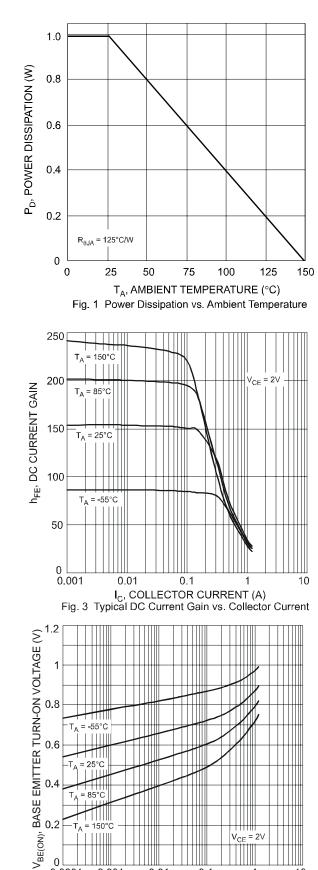
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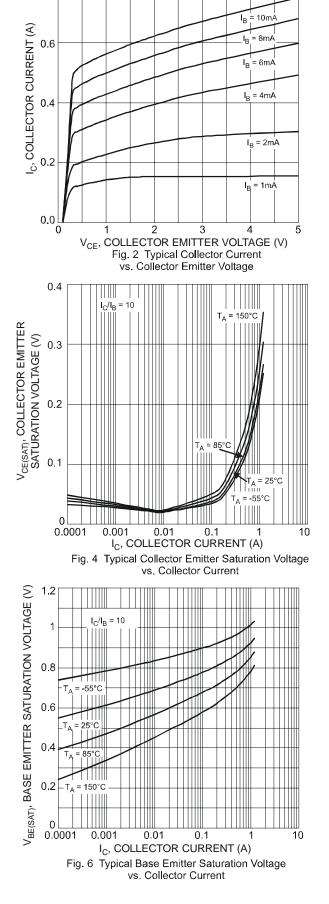
Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php. Device mounted on FR-4 PCB; pad layout as shown on page 4 or in Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 3.

Measured under pulsed conditions. Pulse width = 300μ s. Duty cycle $\leq 2\%$. 4.

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0.8

0.0001

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25°C

85°C

150°0

0.001

0.01

0.1

I_C, COLLECTOR CURRENT (A) Fig. 5 Typical Base Emitter Turn-On Voltage

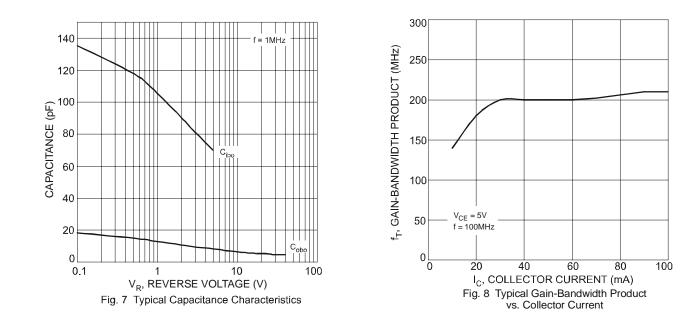
vs. Collector Current

V_{CE} = 2V

1

10



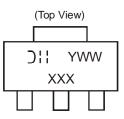


Ordering Information (Note 5)

Device	Packaging	Shipping
DCX56-13	SOT89-3L	2500/Tape & Reel
DCX56-16-13	SOT89-3L	2500/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/ap02007.pdf.

Marking Information

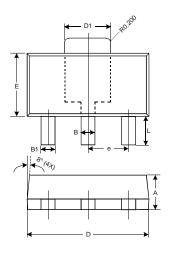


XXX = Product Type Marking Code ex. N18 = DCX56

N18-16 = DCX56-16

>II = Manufacturer's code marking
YWW = Date Code Marking
Y = Last digit of year ex: 7 = 2007
WW = Week code 01 - 52

Package Outline Dimensions

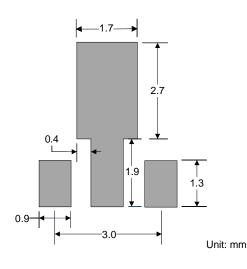


SOT89-3L					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.45	0.55	0.50		
B1	0.37	0.47	0.42		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.50	1.70	1.60		
Е	2.40	2.60	2.50		
е	_	_	1.50		
н	3.95	4.25	4.10		
L	0.90	1.20	1.05		
All C	All Dimensions in mm				

DS31161 Rev. 3 - 2



Suggested Pad Layout



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